



# **PNP Silicon Transistor**

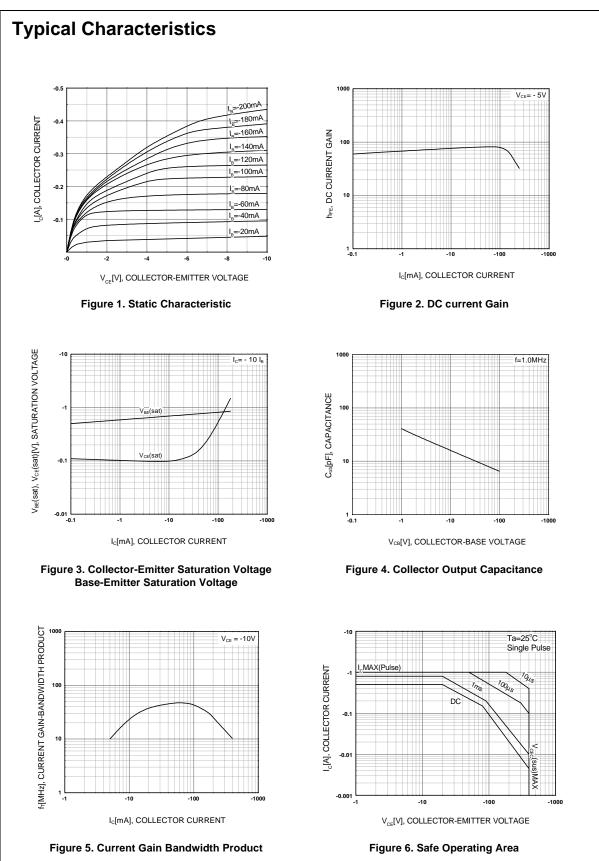
Symbol	Parameter	Ratings	Units
V <sub>CBO</sub>	Collector-Base Voltage	-400	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-400	V
V <sub>EBO</sub>	Emitter-Base Voltage	-7	V
в	Base Current	-0.25	A
С	Collector Current (DC)	-0.5	A
СР	Collector Current (Pulse)	-1.0	A
Pc	Collector Power Dissipation (T <sub>a</sub> =25°C)	0.75	W
I <sub>CP</sub> P <sub>C</sub> P <sub>C</sub>	Collector Power Dissipation (T <sub>C</sub> =25°C)	2	W
Т <sub>Ј</sub>	Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature	-55 ~ 150	°C

## Electrical Characteristics Ta=25°C unless otherwise noted

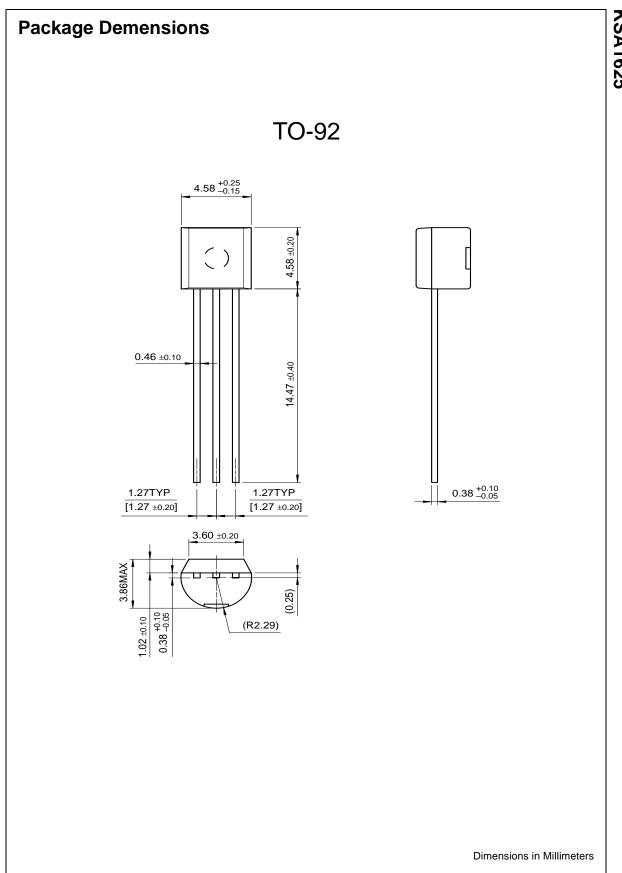
Symbol	Parameter	Test Condition	Min.	Max.	Units
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = -1mA, I <sub>B</sub> =0	-400		V
I <sub>CBO</sub>	Collector Cut-off Current	V <sub>CB</sub> = -400V, I <sub>E</sub> =0		-1	μΑ
IEBO	Emitter Cut-off Current	V <sub>EB</sub> = -5V, I <sub>C</sub> =0		-1	μA
h <sub>FE</sub>	Dc Current Gain	V <sub>CE</sub> = -5V, I <sub>C</sub> = -50mA	40	200	AV.
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -100mA, I <sub>B</sub> = -10mA		-1	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = -100mA, I <sub>B</sub> = -10mA	202	-1.2	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = -10V, I <sub>C</sub> = -10mA	10		MHz
C <sub>ob</sub>	Output Capacitance	V <sub>CB</sub> = -10V, f=1MHz		25	pF
t <sub>ON</sub>	Turn On Time	I <sub>C</sub> = -100mA, R <sub>L</sub> =1.5kΩ		1	μs
t <sub>STG</sub>	Storage Time	I <sub>B1</sub> =- I <sub>B2</sub> = -10mA		5	μs
t <sub>F</sub>	Fall Time	V <sub>CC</sub> = -150V		1	μs

# h<sub>FE</sub> Classification

Classification	М	L	К
h <sub>FE</sub>	40 ~ 80	60 ~ 120	100 ~ 200



# KSA1625



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